

N-Channel 650V (D-S) Super Junction Power MOSFET

PRODUCT SUMMARY				
V _{DS} (V) at T _J max.	650			
R _{DS(on)} typ. (Ω) at 25 °C	V _{GS} = 10 V	0.161		

FEATURES

- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (Ciss)
- · Reduced switching and conduction losses
- Ultra low gate charge (Qq)
- Avalanche energy rated (UIS)



APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
- Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
- Motor drives
- Battery chargers
- Renewable energy
- Solar (PV inverters)

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TopView	N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)					
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-source voltage			V _{DS}	650	V
Gate-source voltage			V_{GS}	± 30	
Continuous drain current (T _J = 150 °C)	V at 10 V	$T_C = 25 ^{\circ}C$ $T_C = 100 ^{\circ}C$	- I _D	20	А
	V _{GS} at 10 V	T _C = 100 °C		12	
Pulsed drain current ^a			I _{DM}	60	1
Linear derating factor				1.7	W/°C
Single pulse avalanche energy b			E _{AS}	390	MJ
Maximum power dissipation			P_D	170	W
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C
Drain-source voltage slope	T _J = 125 °C		dV/dt	50	V/ns
Reverse diode dV/dt ^d			uv/ut	5.1	V/IIS
Soldering recommendations (peak temperature) ^c	For 10 s			260	°C

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b. V_{DD} = 100 V, starting T_J = 25 °C, L = 30 mH, R_g = 25 Ω , I_{AS} = 8.0 A
- c. 1.6 mm from case
- d. $I_{SD} \le I_D$, $dI/dt = 100 \text{ A/}\mu\text{s}$, starting $T_J = 25 \,^{\circ}\text{C}$

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THERMAL RESISTANCE RATINGS						
PARAMETER	SYMBOL	TYP.	MAX.	UNIT		
Maximum junction-to-ambient	R _{thJA}	=	62	°C/W		
Maximum junction-to-case (drain)	R _{thJC}	-	0.65			

PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static		-					
Drain-source breakdown voltage	V _{DS}	Vgs = 0 V, ID = 250 μA		650	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference to 25 °C, I _D = 1 mA		-	1.08	-	V/°C
Gate-source threshold Voltage (N)	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$		2.0	-	4.0	V
	I _{GSS}	$V_{GS} = \pm 20 \text{ V}$		-	-	± 100	nA
Gate-source leakage			$V_{GS} = \pm 30 \text{ V}$		-	± 1	μΑ
7		V _{DS} =	V _{DS} = 480 V, V _{GS} = 0 V		-	1	
Zero gate voltage drain current	I _{DSS}	V _{DS} = 480 \	/, V _{GS} = 0 V, T _J = 125 °C	-	-	10	μA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	ID =10A	-	0.161	-	Ω
Forward transconductance	9 _{fs}	$V_{DS} = 30 \text{ V}, I_{D} = 6A$		-	8.7	-	S
Dynamic							
Input capacitance	C _{iss}	V _{GS} = 0 V,		-	2500	-	
Output capacitance	C _{oss}		$V_{DS} = 100 \text{ V},$ f = 1 MHz		81	-	
Reverse transfer capacitance	C _{rss}	7			9	-	
Effective output capacitance, energy related ^a	C _{o(er)}	V _{DS} = 0 V to 480 V, V _{GS} = 0 V		-	58	-	pF
Effective output capacitance, time related ^b	C _{o(tr)}			-	296	-	
Total gate charge	Qg		V _{GS} = 10 V	-	78	122	nC
Gate-source charge	Q _{gs}	V _{GS} = 10 V		-	16	-	
Gate-drain charge	Q_{gd}			-	20	-	
Turn-on delay time	t _{d(on)}	'		-	24	40	
Rise time	t _r	Vpp	$V_{DD} = 480 \text{ V}, I_D = 5 \text{ A},$		25	35	ne
Turn-off delay time	t _{d(off)}	$V_{GS} = 400 \text{ V}, T_{G} = 3 \text{ A},$ $V_{GS} = 10 \text{ V}, R_{g} = 9.1 \Omega$		-	28	32	ns
Fall time	t _f				25	30	
Gate input resistance	R_g	f = 1 MHz, open drain		0.3	0.7	1.4	Ω
Drain-Source Body Diode Characteristic	s						
Continuous source-drain diode current	Is	MOSFET sym	MOSFET symbol showing the		-	20	_
Pulsed diode forward current	I _{SM}	integral reverse p - n junction diode		-	-	60	- A
Diode forward voltage	V _{SD}	T _J = 25 °C, I _S = 5 A, V _{GS} = 0 V		-	-	1.2	V
Reverse recovery time	t _{rr}	$T_J = 25 \text{ °C}, I_F = I_S = 5 \text{ A},$ $dI/dt = 100 \text{ A/}\mu\text{s}, V_R = 25 \text{ V}$		-	25	-	ns
Reverse recovery charge	Q _{rr}			-	6.4	12.8	μC
Reverse recovery current	I _{RRM}			-	27	_	A

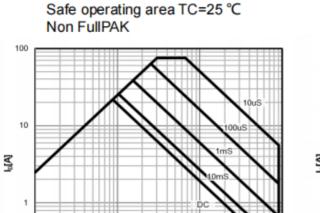
Notes

- a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}

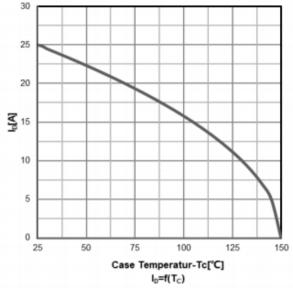
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

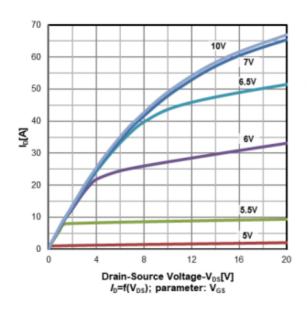


Drain current vs temperature

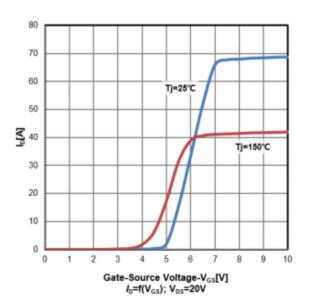


Typ. output characteristics T_i =25 $^{\circ}C$

Drain-Source Voltage-V_{DS}[V] I_D=f(V_{DS}); parameter t_p 1000



Typ. transfer characteristics



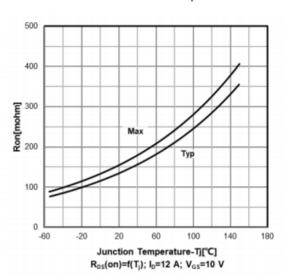
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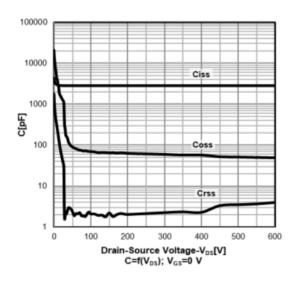
Typ. drain-source on-state resistance

100 | Source Current-l_D[A] | R_{DS}(on)=f(I_D); parameter:V_{GS}

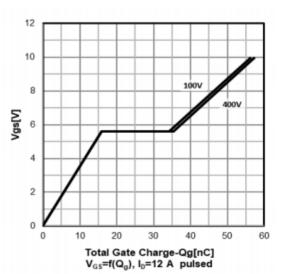
On resistance vs temperature



Typ. capacitances



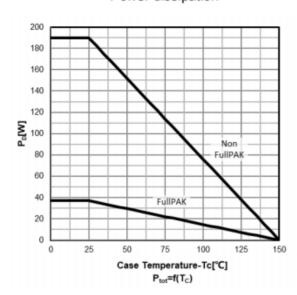
Typ. gate charge characteristics



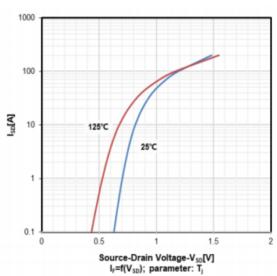
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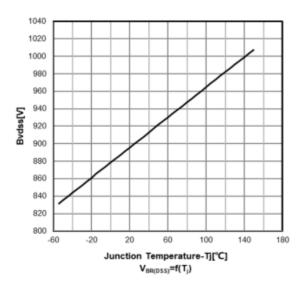
Power dissipation



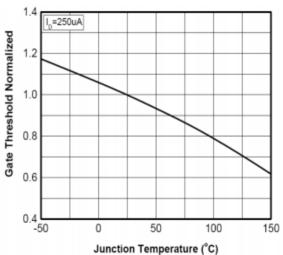
Forward characteristics of reverse diode



Drain-source breakdown voltage



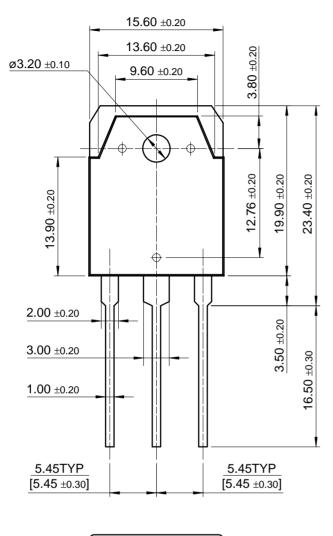
Normalized $V_{\text{GS(th)}}$ characteristics

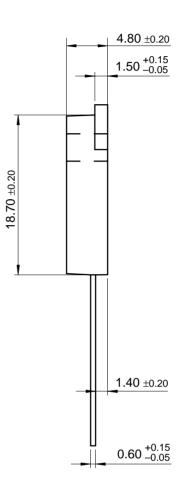


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